

AGTechnologies

# SPECIFICATION AGM 2002A-206

Atualizado em 05/06/19

	AGTechno	ologies	MODLE NO : AGM 2002A-206					
REC	ORDS OF REV	VISION	DOC. FIRST ISSUE					
VERSION	DATE	REVISED PAGE NO.	SUMMARY					
0	2007/01/16		First issue					
Α	2008/10/23		Modify Character					
			Generator ROM Pattern					
В	2012/09/03		Correct ST7066IC					
			information.					
С	2013/07/08		Remove IC information					

# Contents

- 1.Precautions in use of LCD Modules
- 2. General Specification
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- **4.Electrical Characteristics**
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- 9.Reliability
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- 13.Recommendable Storage

# **1.Precautions in use of LCD Modules**

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) AGT have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) AGT have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, AGT have the right to modify the version.)

# **2.General Specification**

Item	Dimension	Unit
Number of Characters	20 characters x 2Lines	_
Module dimension	116.0 x 37.0 x 13.9 (MAX)	mm
View area	85.0 x 18.6	mm
Active area	73.5x 11.5	mm
Dot size	0.60 x 0.65	mm
Dot pitch	0.65 x 0.70	mm
Character size	3.20 x 5.55	mm
Character pitch	3.70 x 5.95	mm
LCD type	STN Positive, Yellow Green Transflective (In LCD production, It will occur slightly color can only guarantee the same color in the same b	
Duty	1/16	
View direction	6 o'clock	
Backlight Type	LED, Yellow Green	
IC	ST7066U	

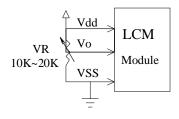
# **3.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T <sub>OP</sub>	-20	_	+70	°C
Storage Temperature	T <sub>ST</sub>	-30	_	+80	°C
Input Voltage	VI	V <sub>SS</sub>	_	V <sub>DD</sub>	V
Supply Voltage For Logic	V <sub>DD</sub> -V <sub>SS</sub>	-0.3	_	7	V
Supply Voltage For LCD	V <sub>DD</sub> -V <sub>o</sub>	-0.3	_	13	V

# **4.Electrical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	_	4.5	5.0	5.5	V
Supply Voltage For LCD		<b>Та=-20</b> °С	_		5.7	V
*Note	$V_{DD}$ - $V_0$	Ta=25°C	4.2	4.35	4.5	V
		Ta=70°C	3.8	—	—	V
Input High Volt.	V <sub>IH</sub>	_	0.7 V <sub>DD</sub>	_	V <sub>DD</sub>	V
Input Low Volt.	V <sub>IL</sub>	—	Vss	_	0.6	V
Output High Volt.	V <sub>OH</sub>	—	3.9	_	Vdd	V
Output Low Volt.	V <sub>OL</sub>	_	0	_	0.4	V
Supply Current	I <sub>DD</sub>	V <sub>DD</sub> =5.0V	1.0	1.2	1.5	mA

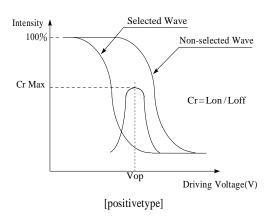
\* Note: Please design the VOP adjustment circuit on customer's main board



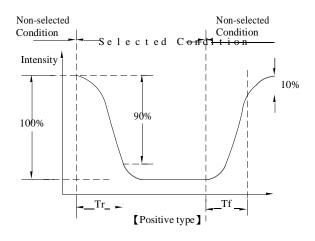
# **5.Optical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	$CR \ge 2$	0	_	20	$\psi=180^{\circ}$
X7: A 1-	θ	$CR \ge 2$	0	_	40	$\Psi = 0^{\circ}$
View Angle	θ	$CR \ge 2$	0	_	30	$\Psi = 90^{\circ}$
	θ	$CR \ge 2$	0	_	30	$\Psi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
Descrete Time	T rise	_	_	150	200	ms
Response Time	T fall	_	_	150	200	ms

#### **Definition of Operation Voltage (Vop)**



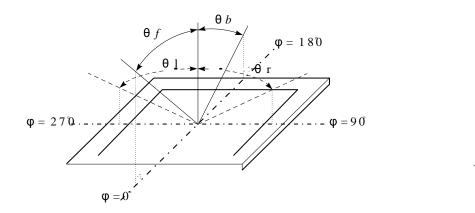
Definition of Response Time (Tr, Tf)



**Conditions :** 

Operating Voltage : Vop Frame Frequency : 64 HZ Viewing Angle( $\theta \rightarrow \phi$ ) :  $0^{\circ} \rightarrow 0^{\circ}$ Driving Waveform : 1/N duty , 1/a bias

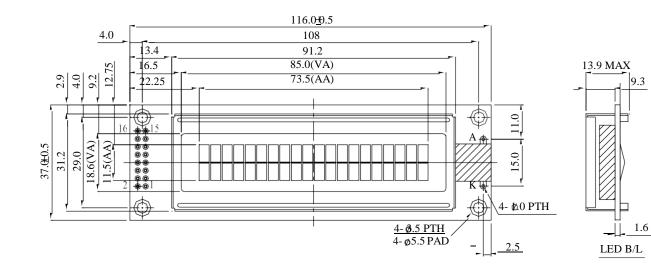
### Definition of viewing angle(CR≧2)



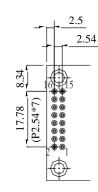
# **6.Interface Pin Function**

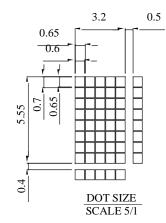
Pin No.	Symbol	Level	Description
1	V <sub>SS</sub>	0V	Ground
2	V <sub>DD</sub>	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU $\rightarrow$ Module) L: Write(MPU $\rightarrow$ Module)
6	Е	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	А	_	Power supply for B/L +
16	K		Power supply for B/L -

## **7.Contour Drawing & Block Diagram**

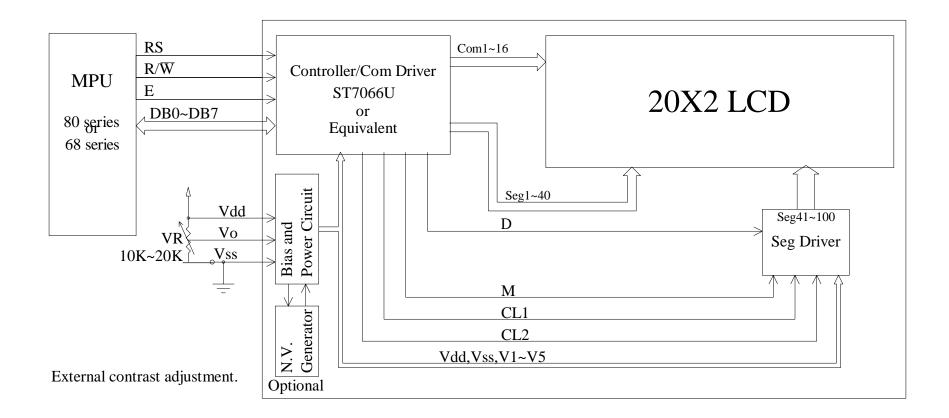


PIN NO.	SYMBOL
1	Vss
2	Vdd
3	Vo
4	RS
5	R/W
6	Е
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	А
16	K





The non-specified tolerance of dimension is 0.3mm.



Character located	1	2	3	4	5	6	7	8	9	10 1	111	21	31	4 1:	5 16	5 17	18	19	20	
DDRAM address	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F	10	11	12	1

DDRAM address	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F	10	11	12	13
DDRAM address	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F	50	51	52	53

## **8.Character Generator ROM Pattern**

Table.2

Upper																
4 bit Lower	LLLL	LLLH I	LHL L	<b>L</b> НН LН	LL LHI	н гнн	L LHHI	H HLLL	HLLH	нгнг н	снн н	HLL HE	LH HH	нг нн	нн	
4 bit							_									
LLLL	CG RAM (1)				444 444 4444 4444 4444 4444 4444 4444 4444	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	** **	5555 5 5 5				****	5555 555 555 55	555 555 555 5	444 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	៨៨៩៩៩៩៩៩៩៩ ៩ ៩ ៩ ៩ ៩ ៩
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LLHL	(3)		ಚಿತ್ ಚಿತ್ರಿ	555 5 5 5 5	66666 66666 66666 6666 6666 7566 7566 7	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	66666 6 6 6 6 6 6 6 6	5 55 55 5 5			19 19 19 19 19	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5		សសសស ៥៥៥៥ ៥៥៥៥ ៥៥៥៥	9999 898 898 898 898 898 898 898 898 89
LLHH	(4)		4 6 46666 46666 46666	55555 55555 5 5 5 5 5 5 5	444 444 444 444 444 444 444 444 444 44	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	5555 5555	5 5 5 5 5 5 5 5 5 5			80	666 66 66 66 66 66 66 66 66 66 66 66 66	5 555 5555 55 55	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	៤៥ ៥ ២៥៥ ២៥៥ ៥	66 6 6 6 7 7 7 7
LHLL	(5)		៥ ៥ ៥៥ ៥៥ ៥ ៥៥ ៥ ៥ ៥៥		የቆቆቆ	ት የማፅሳሳሳ የ የ የ የ የ የ የ የ የ የ የ የ የ የ የ የ የ የ	የቆ	4 4 4 4 4 4 4 4 4 4 4 4			555	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	ទី៩៩៩៩ ៤ ៥	៥៥៥៥ ៥ ៥ ៥ ៥ ៥ ៥៥ ៥	bbbb d bbbb	년 년 년 년 년 년 147 년
LHLH	(6)			55555 55555 55555 55555 55555 55555 5555	6666 6666 66 66 66 66 66 66 66 66 66 66			66 6 6 6 6 6 6 7			19 19 19 19	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2		e eel	888° 8898 668° 6 868° 6 868° 6	200000 2 2 3000000
LHHL	(7)		**************************************	*****	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	6666 6666 6666 6666 6666 6666 666	*****	55 55 55 55 55 55 55			<u>**</u> *	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	** ** ***	*****		- <b></b> 
LHHH	(8)		55 55 55 55	5000 5000 5000 50000 50000		9446 9466 9466 9466 94	240 44 44 44 44 44 44 44 44 44 44 44 44 4				50005 5	*****	88888 88888 88888	5555 5555 5555 5555	88 00000	1999 1999 1999 1999
HLLL	(1)		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	7 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8			10 10 10 10 10 10 10 10 10 10 10 10 10 1	5 5 5 5			10000000000000000000000000000000000000	22222 22222 22222 22222 22222 22222 2222	2 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8	24444 24444 24444 24444	ያ የትትት የትትት ይ ሮ ይ ሮ ይ ሮ ይ ሮ	******
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HLHL	(3)		5 555	22		\$\$\$ \$ 5	6 6 6 6 6 6 6 6 6	55555 5 5			55555	56666 6 5		2 2 2 2		5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5
нгнн	(4)		5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5		886 888 8 8 8 8 8 8 8 8 8 8 8 8 8		៥៩៩៩៩៩ ៩ ៩៩៩ ៩ ៩៩៩ ៩	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2			5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5			19 <b>1</b> 9	555 555 555	2 64446 6446 64 6 64 6 844 6 84 6 8
HHLL	(5)		55 55 55	-	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	555 555 5555 5555 5555 5555 555 555 55	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	d d dd dddddd			5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	5 5 5 5 5 5	55555 55 55 55 55		ታ የት ሮ የት የት	ස්ස්ස්ස් ස් ස් ස්ස්ස් ස්ස්ස්ස්
ннЕн	(6)		555 55	5 5	୯୯୯୯୯୯୯ ୯୯୯୯୦ଏଟ ୯ ୯ ୯ ୯୯୯୯୯୯ ୯୯୯୯୦	234 88 88 88 88 88 88 88 88 88 88 88 88 88	ታራራት የትትም	2 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8			**** *****	**************************************	44 4 44444 44444 44 4 44 4 44 4	5 5 5 5 5 5 5 5	해서해서	<u>5</u> 55555 5
			55 5	5 5 5 5 5	4 4 6 6 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7	55555	5 5 5555 5555 5555 5555	5			5555 555 555 55	5555 5555 5555	555555 555555 555 555 55	55 55 55 55 55 55 55 55 55 55 55 55 55	សំសំ <sup>ស</sup> ទោធ ខ្មាំ សំស័ម សំស័ម	282818184848184848 2838818484888 2838818484888 28388184848888 283881849488888

# 9. Reliability

### Content of Reliability Test (Wide temperature, -20°C~70°C)

	<b>Environmental Test</b>		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 $^{\circ}$ C,90% RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C ,90% RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation $-20^{\circ}C$ 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5k $\Omega$ CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

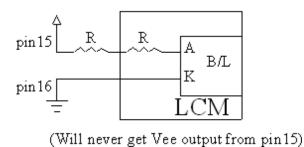
# **10.Backlight Information**

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNIT	TEST CONDITION
Supply Current	ILED	168	210	252	mA	V=4.2V
Supply Voltage	V	4.0	4.2	4.4	V	-
Reverse Voltage	VR	-	-	8	V	-
Luminance (Without LCD)	IV	210	260	-	CD/M <sup>2</sup>	ILED=210mA
Wave Length	λр	568	570	574	nm	ILED=210mA
Life Time	-	-	100000	-	Hr.	ILED≦210mA 25°C,50-60%RH
Color	Yellow Gro	een			1	

## Specification

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

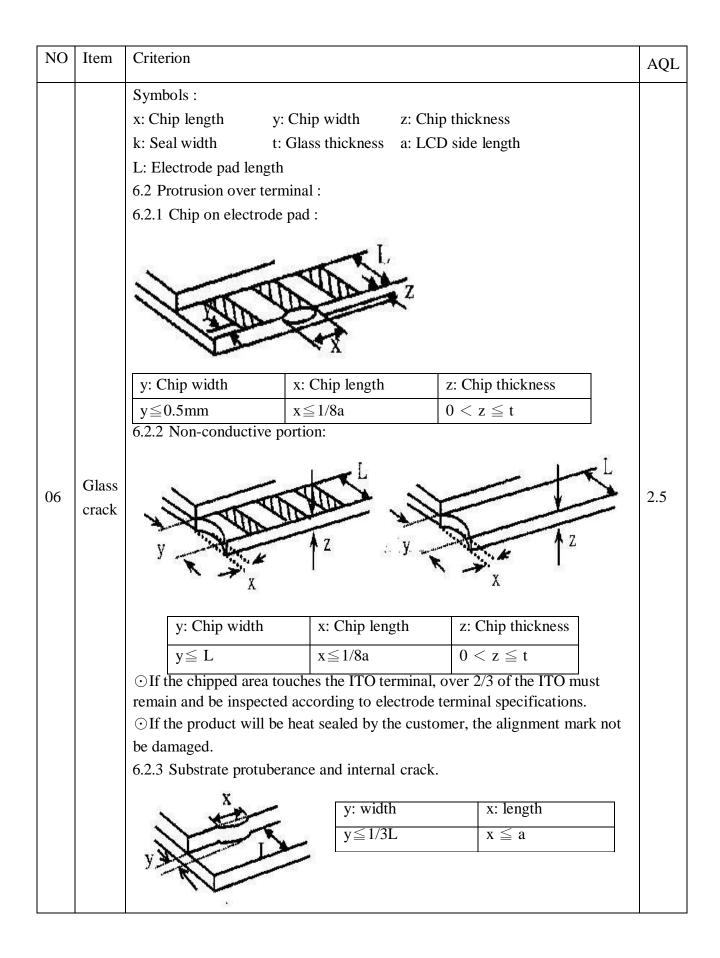
2.Drive from pin15,pin16



# **11.Inspection specification**

NO	Item	Criterion				AQL
01	Electrical Testing Black or	Missing vertical, horizontal segment, segment contrast defect. Missing character , dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect.				0.65
02	white spots on LCD (display only)	2.1 White and black spots on display $\leq 0.25$ mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm				2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi = (x + y) / 2$	Γ	wing drawing         SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0	2.5
		3.2 Line type : $\frac{1}{L} = \frac{W}{L}$	(As follow Length  L $\leq 3.0$ L $\leq 2.5$ 	Width         W $\leq$ 0.02         0.02 < W $\leq$ 0.03         0.03 < W $\leq$ 0.05         0.05 < W	Acceptable Q TYAccept no dense2As round type	2.5
04	Polarizer bubbles	If bubbles are v judge using bla specifications, i to find, must ch specify directio	ck spot not easy neck in	Size $\Phi$ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

NO	Item	Criterion				
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination				
06	Chipped glass	Symbols Define:         x: Chip length       y: Chip width       z: Chip thickness         k: Seal width       t: Glass thickness       a: LCD side length         L: Electrode pad length:       6.1 General glass chip :       6.1.1 Chip on panel surface and crack between panels:         Image: Chip of the structure of the stru				
		z: Chip thickness $Z \leq 1/2t$ $1/2t < z \leq 2t$	y: Chip width Not over viewing area Not exceed 1/3k	x: Chip length $x \le 1/8a$ $x \le 1/8a$	2.5	
		<ul> <li>⊙ If there are 2 or more</li> <li>6.1.2 Corner crack:</li> </ul>	re chips, x is total lengtl	h of each chip.		
		z: Chip thickness $Z \le 1/2t$	y: Chip width Not over viewing	x: Chip length $x \le 1/8a$		
		$1/2t < z \leq 2t$	area Not exceed 1/3k	$x \leq 1/8a$		
		'⊙If there are 2 or more	re chips, x is the total le	ngth of each chip.		



NO	Item	Criterion	AQL	
07	Cracked glass	The LCD with extensive crack is not acceptable.8.1 Illumination source flickers when lit.		
	Backlight elements	8.1 Illumination source flickers when lit.		
08		8.2 Spots or scratched that appear when lit must be judged.		
		Using LCD spot, lines and contamination standards.		
		8.3 Backlight doesn't light or color wrong.	0.65	
	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints,		
09		stains or other contamination.		
		9.2 Bezel must comply with job specifications.	0.65	
		10.1 COB seal may not have pinholes larger than 0.2mm or		
		contamination.		
		10.2 COB seal surface may not have pinholes through to the IC.		
	PCB \ COB	10.3 The height of the COB should not exceed the height	0.65	
		indicated in the assembly diagram.		
		10.4 There may not be more than 2mm of sealant outside the		
		seal area on the PCB. And there should be no more than three		
		places.		
		10.5 No oxidation or contamination PCB terminals.	2.5	
10		10.6 Parts on PCB must be the same as on the production		
10		characteristic chart. There should be no wrong parts, missing		
		parts or excess parts.		
		10.7 The jumper on the PCB should conform to the product	0.65	
		characteristic chart.		
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or		
		screw hold pad, make sure it is smoothed down.		
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5	
		X		
		$\mathbf{Y}$ X * Y<=2mm2		
11	Soldering	11.1 No un-melted solder paste may be present on the PCB.	2.5	
		11.2 No cold solder joints, missing solder connections,	2.5	
		oxidation or icicle.		
		11.3 No residue or solder balls on PCB.	2.5	
		11.4 No short circuits in components on PCB.	0.65	

NO	Item	Criterion	AQL
NO 12	Item General appearance	<ul> <li>12.1 No oxidation, contamination, curves or, bends on interface</li> <li>Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the interface</li> <li>pin must be present or look as if it cause the interface pin to sever.</li> <li>12.6 The residual rosin or tin oil of soldering (component or chip</li> <li>component) is not burned into brown or black color.</li> <li>12.7 Sealant on top of the ITO circuit has not hardened.</li> <li>12.8 Pin type must match type in specification sheet.</li> </ul>	<ul> <li>2.5</li> <li>0.65</li> <li>2.5</li> <li>2.5</li> <li>2.5</li> <li>2.5</li> <li>2.5</li> <li>0.65</li> </ul>
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	0.57
		12.11 Product dimension and structure must conform to product specification sheet.	0.65
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

# <u>12.Material List of Components for</u> <u>RoHs</u>

1. AGTECHNOLOGIES PRODUTOS ELETRONICOS, Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

2.Process for RoHS requirement :

- (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow :  $250^{\circ}$ C, 30 seconds Max. ;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. :  $235\pm5^{\circ}C$ ;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

# **13.Recommendable Storage**

- 1. Place the panel or module in the temperature  $25^{\circ}C\pm 5^{\circ}C$  and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.